

## Silicon Power Schottky Diode

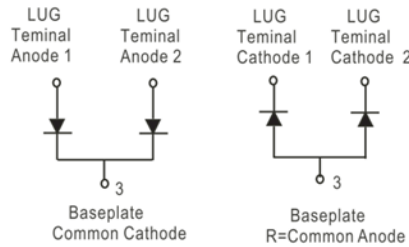
$V_{RRM} = 45\text{ V} - 100\text{ V}$

$I_{F(AV)} = 300\text{ A}$

### Features

- High Surge Capability
- Types from 45 V to 100 V  $V_{RRM}$
- Not ESD Sensitive

### Twin Tower Package



### Maximum ratings, at $T_j = 25\text{ }^\circ\text{C}$ , unless otherwise specified ("R" devices have leads reversed)

Parameter	Symbol	Conditions	MBR30045CT(R)	MBR30060CT(R)	MBR30080CT(R)	MBR300100CT(R)	Unit
Repetitive peak reverse voltage	$V_{RRM}$		45	60	80	100	V
RMS reverse voltage	$V_{RMS}$		32	42	57	70	V
DC blocking voltage	$V_{DC}$		45	60	80	100	V
Operating temperature	$T_j$		-55 to 150	-55 to 150	-55 to 150	-55 to 150	$^\circ\text{C}$
Storage temperature	$T_{stg}$		-55 to 150	-55 to 150	-55 to 150	-55 to 150	$^\circ\text{C}$

### Electrical characteristics, at $T_j = 25\text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	MBR30045CT(R)	MBR30060CT(R)	MBR30080CT(R)	MBR300100CT(R)	Unit
Average forward current (per pkg)	$I_{F(AV)}$	$T_C = 125\text{ }^\circ\text{C}$	300	300	300	300	A
Peak forward surge current (per leg)	$I_{FSM}$	$t_p = 8.3\text{ ms}$ , half sine	2000	2000	2000	2000	A
Maximum forward voltage (per leg)	$V_F$	$I_{FM} = 150\text{ A}$ , $T_j = 25\text{ }^\circ\text{C}$	0.70	0.75	0.84	0.84	V
Reverse current at rated DC blocking voltage (per leg)	$I_R$	$T_j = 25\text{ }^\circ\text{C}$ $T_j = 100\text{ }^\circ\text{C}$ $T_j = 150\text{ }^\circ\text{C}$	1 10 50	1 10 50	1 10 50	1 10 50	mA

### Thermal characteristics

Parameter	Symbol	Conditions	MBR30045CT(R)	MBR30060CT(R)	MBR30080CT(R)	MBR300100CT(R)	Unit
Thermal resistance, junction-case, per leg	$R_{\theta JC}$		0.40	0.40	0.40	0.40	$^\circ\text{C/W}$

Figure .1- Typical Forward Characteristics

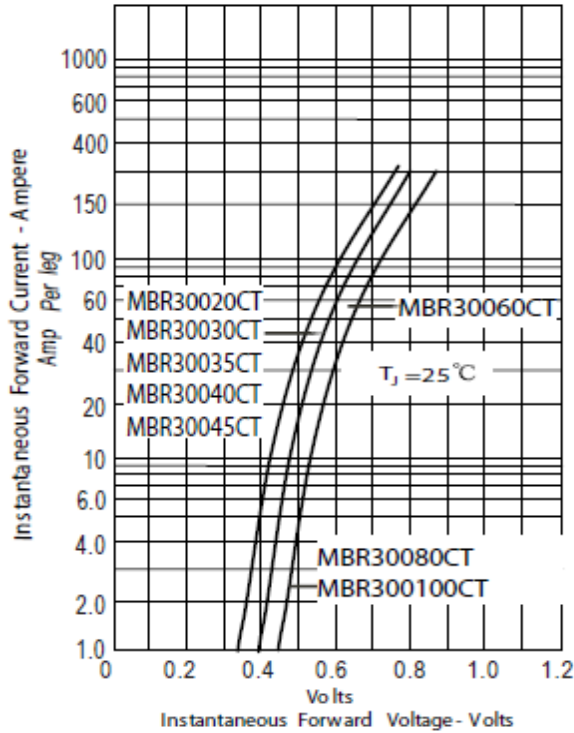


Figure .2- Forward Derating Curve

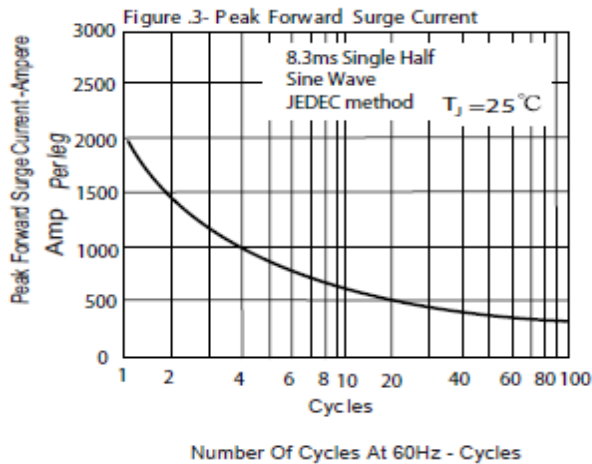
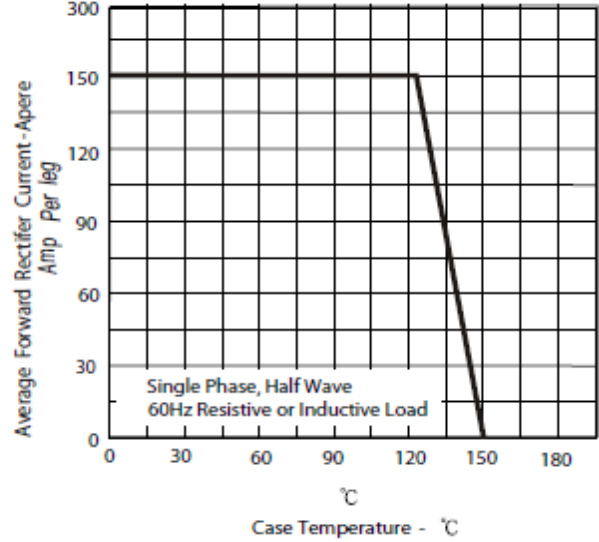
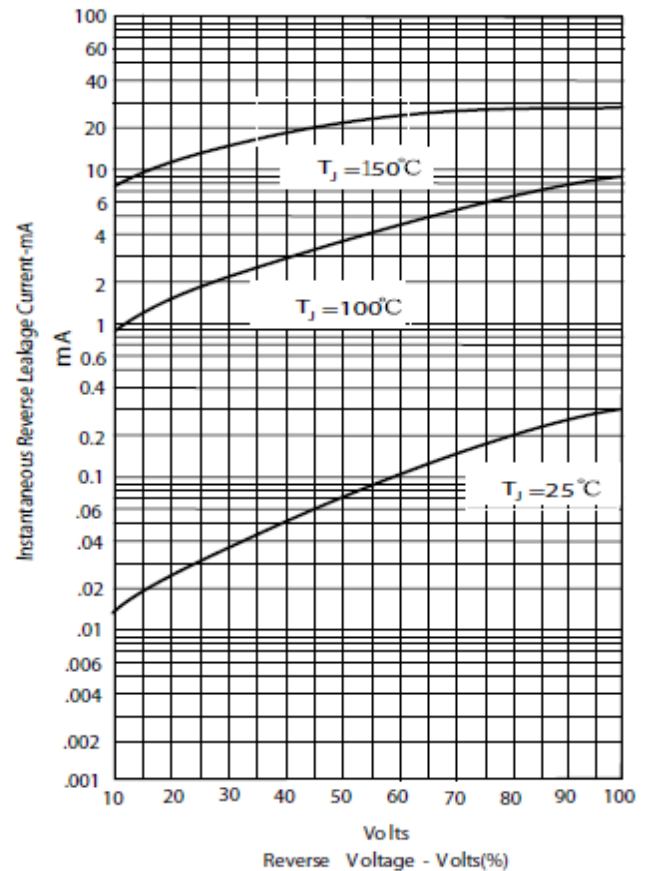
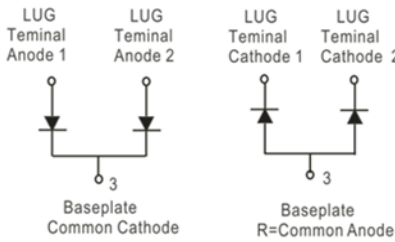
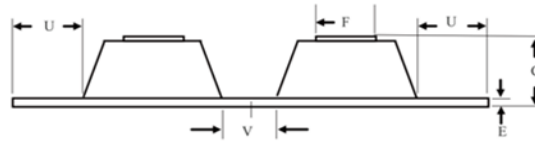
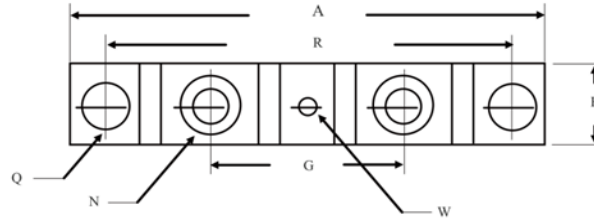


Figure .4- Typical Reverse Characteristics



## Package dimensions and terminal configuration

Product is marked with part number and terminal configuration.



DIM	Inches		Millimeters	
	Min	Max	Min	Max
A	-----	3.630	-----	92.40
B	0.700	0.800	17.78	20.32
C	-----	0.650	-----	16.51
E	0.130	0.141	3.30	3.60
F	0.482	0.490	12.25	12.45
G	1.368	BSC	34.75	BSC
N	1/4-20 UNC FULL			
Q	0.275	0.290	6.99	7.37
R	3.150	BSC	80.01	BSC
U	0.600	-----	15.24	-----
V	0.312	0.370	7.92	9.40
W	0.180	0.195	4.57	4.95

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